CY29949

2.5 V or 3.3 V 200 MHz 1:15 Clock Distribution Buffer

Features

- 2.5 V or 3.3 V operation
- 200-MHz clock support
- LVPECL or LVCMOS/LVTTL clock input
- LVCMOS/LVTTL compatible outputs
- 15 clock outputs: drive up to 30 clock lines
- 1X and 1/2X configurable outputs
- Output three-state control
- 350 ps maximum output-to-output skew
- Pin compatible with MPC949, MPC9449
- Available in Industrial temperature range
- 52-pin TQFP package

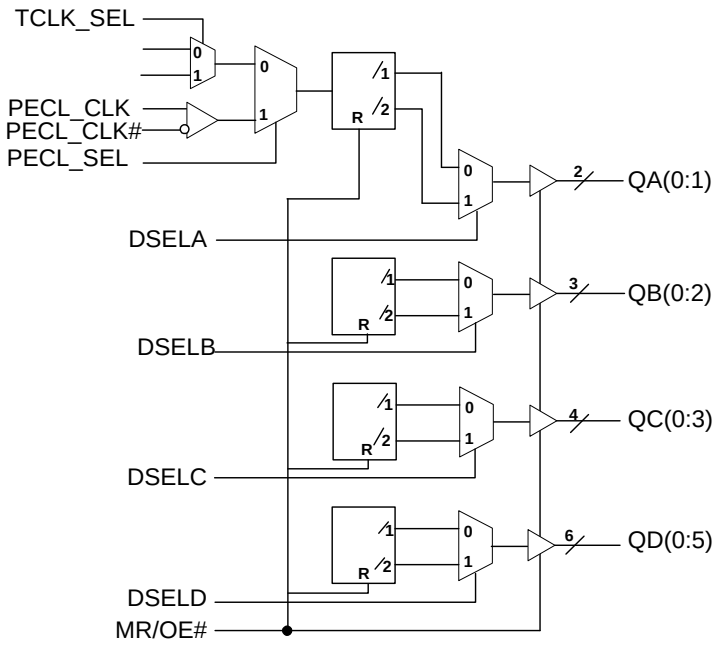
Description

The CY29949 is a low voltage 200 MHz clock distribution buffer with the capability to select either a differential LVPECL or LVCMOS/LVTTL compatible input clocks. These clock sources are used to provide for test clocks and primary system clocks. All other control inputs are LVCMOS/LVTTL compatible. The 15 outputs are LVCMOS or LVTTL compatible and can drive 50Ω series or parallel terminated transmission lines. For series terminated transmission lines, each output can drive one or two traces giving the device an effective fanout of 1:30.

The CY29949 is capable of generating 1X and 1/2X signals from a 1X source. These signals are generated and retimed internally to ensure minimal skew between the 1X and 1/2X signals. SEL(A:D) inputs allow flexibility in selecting the ratio of 1X to1/2X outputs.

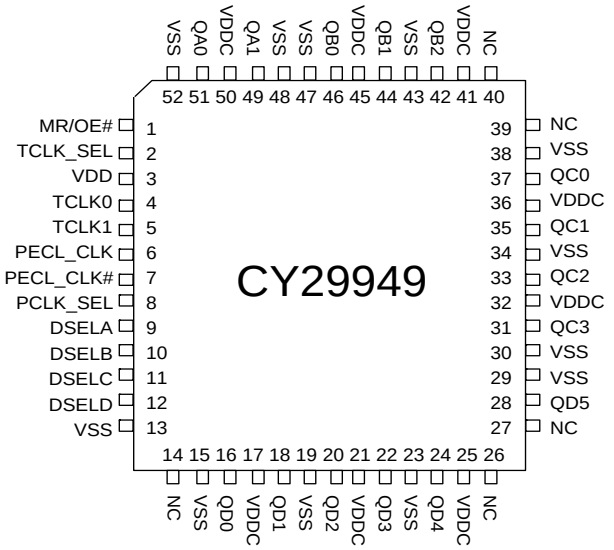
The CY29949 outputs can also be three-stated via the MR/OE# input. When MR/OE# is set HIGH, it resets the internal flip-flops and three-states the outputs.

Logic Block Diagram



Pin Configuration

Figure 1. Pin Diagram - CY29949



Pin Description

Pin	Name	PWR	I/O[1]	Description
6	PECL_CLK		I, PD	**PECL Input Clock**
7	PECL_CLK#		I, PU	**PECL Input Clock**
4, 5	TCLK(0,1)		I, PU	**External Reference/Test Clock Input**
49, 51	QA(1,0)	VDDC	O	**Clock Outputs**
42, 44, 46	QB(2:0)	VDDC	O	**Clock Outputs**
31, 33, 35, 37	QC(3:0)	VDDC	O	**Clock Outputs**
16, 18, 20, 22, 24, 28	QD(5:0)	VDDC	O	**Clock Outputs**
9, 10, 11, 12	DSEL(A:D)		I, PD	**Divider Select Inputs**. When HIGH, selects ÷2 input divider. When LOW, selects ÷1 input divider.
2	TCLK_SEL		I, PD	**TCLK Select Input**. When LOW, TCLK0 clock is selected and when HIGH TCLK1 is selected.
8	PCLK_SEL		I, PD	**PECL Select Input**. When HIGH, PECL clock is selected and when LOW TCLK(0,1) is selected
1	MR/OE#		I, PD	**Output Enable Input**. When asserted LOW, the outputs are enabled and when asserted HIGH, internal flip-flops are reset and the outputs are three-stated. If more than one bank is used in /2 mode, a reset must be performed (MR/OE# asserted high) after power up to ensure that all internal flip-flops are set to the same state.
17, 21, 25, 32, 36, 41, 45, 50	VDDC			**2.5 V or 3.3 V Power Supply for Output Clock Buffers**
3	VDD			**2.5 V or 3.3 V Power Supply**
13, 15, 19, 23, 29, 30, 34, 38, 43, 47, 48, 52	VSS			**Common Ground**
14, 26, 27, 39, 40,	NC			**Not Connected**

Note
1. PD = internal pull-down, PU = internal pull-up.

Maximum Ratings[2]

Maximum Input Voltage Relative to V_{SS}: ..... V_{SS} – 0.3 V

Maximum Input Voltage Relative to V_{DD}: ..... V_{DD} + 0.3 V

Storage Temperature: ..... –65°C to + 150°C

Operating Temperature: ..... –40°C to +85°C

Maximum ESD Protection ..... 2 kV

Maximum Power Supply: ..... 5.5 V

Maximum Input Current: ..... ±20 mA

This device contains circuitry to protect the inputs against damage due to high static voltages or electric field; however, precautions must be taken to avoid application of any voltage higher than the maximum rated voltages to this circuit. For proper operation, V_{in} and V_{out} should be constrained to the range:

$V_{SS} < (V_{in} \text{ or } V_{out}) < V_{DD}$

Unused inputs must always be tied to an appropriate logic voltage level (either V_{SS} or V_{DD}).

DC Parameters ($V_{DD} = V_{DDC}$ = 3.3 V ±10% or 2.5 V ±5%, over the specified temperature range)

Parameter	Description	Conditions	Min	Typ	Max	Unit
V_{IL}	Input Low Voltage	V_{DD} = 3.3 V, PECL_CLK single ended	1.49	–	1.825	V
		V_{DD} = 2.5 V, PECL_CLK single ended	1.10	–	1.45	
		All other inputs	V_{SS}	–	0.8	
V_{IH}	Input High Voltage	V_{DD} = 3.3 V, PECL_CLK single ended	2.135	–	2.42	V
		V_{DD} = 2.5 V, PECL_CLK single ended	1.75	–	2.0	
		All other inputs	2.0	–	V_{DD}	
I_{IL}	Input Low Current[3]		–	–	–100	µA
I_{IH}	Input High Current[3]		–	–	100	
V_{PP}	Peak-to-Peak Input Voltage PECL_CLK		300	–	1000	mV
V_{CMR}	Common Mode Range[4] PECL_CLK	V_{DD} = 3.3 V	V_{DD} – 2.0	–	V_{DD} – 0.6	V
		V_{DD} = 2.5 V	V_{DD} – 1.2	–	V_{DD} – 0.6	
V_{OL}	Output Low Voltage[5]	I_{OL} = 20 mA	–	–	0.4	V
V_{OH}	Output High Voltage[5]	I_{OH} = –20 mA, V_{DD} = 3.3 V	2.5	–	–	V
		I_{OH} = –20 mA, V_{DD} = 2.5 V	1.8		–	
I_{DDQ}	Quiescent Supply Current		–	5	7	mA
I_{DD}	Dynamic Supply Current	V_{DD} = 3.3 V, Outputs at 100 MHz, CL = 30 pF	–	200	–	mA
		V_{DD} = 3.3 V, Outputs at 160 MHz, CL = 30 pF	–	330	–	
		V_{DD} = 2.5 V, Outputs at 100 MHz, CL = 30 pF	–	140	–	
		V_{DD} = 2.5 V, Outputs at 160 MHz, CL = 30 pF	–	235	–	
Zout	Output Impedance	V_{DD} = 3.3 V	12	15	18	Ω
		V_{DD} = 2.5 V	14	18	22	
C_{in}	Input Capacitance		–	4	–	pF

Notes

2. Multiple Supplies**:** The voltage on any input or I/O pin cannot exceed the power pin during power up. Power supply sequencing is NOT required.
3. Inputs have pull-up/pull-down resistors that effect input current.
4. The V_{CMR} is the difference from the most positive side of the differential input signal. Normal operation is obtained when the “High” input is within the V_{CMR} range and the input lies within the V_{PP} specification.
5. Driving series or parallel terminated 50Ω (or 50Ω to V_{DD}/2) transmission lines.

AC Parameters (V_{DD} = V_{DDC} = 3.3 V ±10% or 2.5 V ±5%, over the specified temperature range)[6]

Parameter	Description	Conditions	Min	Typ	Max	Unit
Fmax	Input Frequency[7]	V_{DD} = 3.3 V	–	–	200	MHz
		V_{DD} = 2.5 V	–	–	170	
Tpd	PECL_CLK to Q Delay[7]	V_{DD} = 3.3 V	4.0	–	8.6	ns
	TCLK to Q Delay[7]		4.2	–	10.5	
	PECL_CLK to Q Delay[7]	V_{DD} = 2.5 V	6.0	–	10.6	
	TCLK to Q Delay[7]		6.2	–	10.5	
FoutDC	Output Duty Cycle[7, 8]	Measured at VDD/2	45	–	55	%
tpZL, tpZH	Output Enable Time (all outputs)		2	–	10	ns
tpLZ, tpHZ	Output Disable Time (all outputs)		2	–	10	ns
Tskew	Output-to-Output Skew[7, 9]		–	250	350	ps
Tskew(pp)	Part-to-Part Skew[10]	PECL_CLK to Q	–	1.5	2.75	ns
		TCLK to Q	–	2.0	4.0	
Tr/Tf	Output Clocks Rise/Fall Time[9]	0.8 V to 2.0 V, V_{DD} = 3.3 V	0.10	–	1.0	ns
		0.6 V to 1.8 V, V_{DD} = 2.5 V	0.10	–	1.3	

Figure 2. LVCMOS_CLK CY29949 Test Reference for V_{CC} = 3.3 V and V_{CC} = 2.5 V

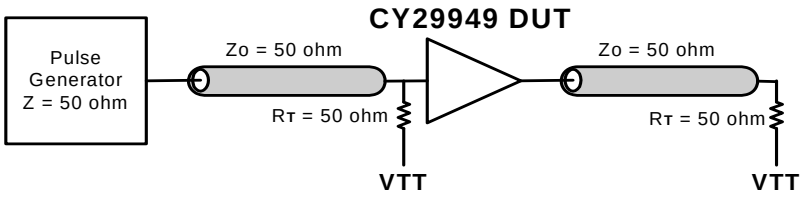
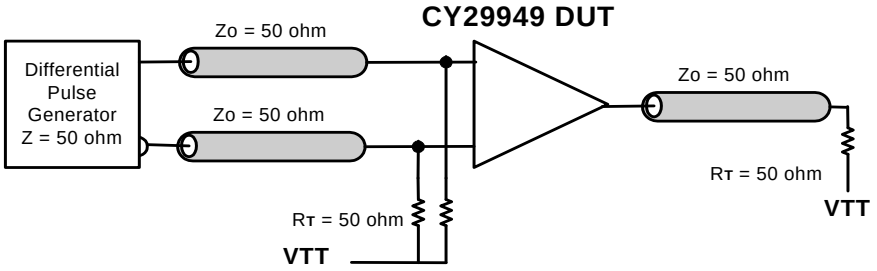


Figure 3. PECL_CLK CY29949 Test Reference for V_{CC} = 3.3 V and V_{CC} = 2.5 V



Notes
6. Parameters are guaranteed by design and characterization. Not 100% tested in production. All parameters specified with loaded outputs.
7. Outputs driving 50Ω transmission lines.
8. 50% input duty cycle.
9. See Figure 2 and Figure 3.
10. Part-to-part skew at a given temperature and voltage.

Figure 4. Propagation Delay (TPD) Test Reference

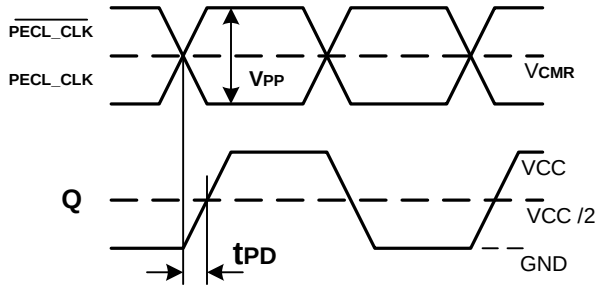


Figure 5. LVCMOS Propagation Delay (TPD) Test Reference

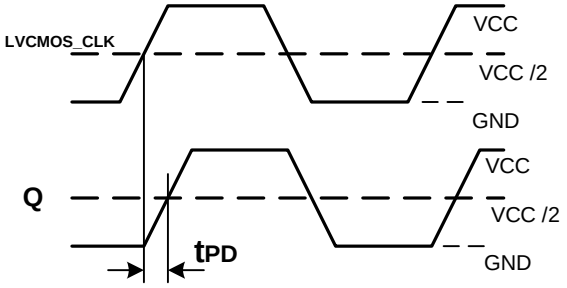


Figure 6. Output Duty Cycle (FoutDC)

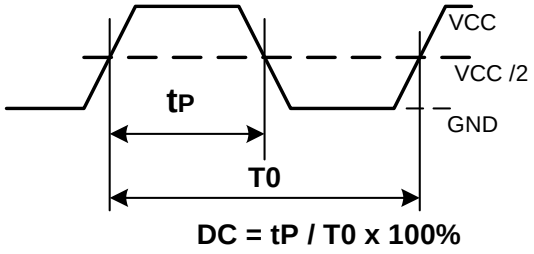
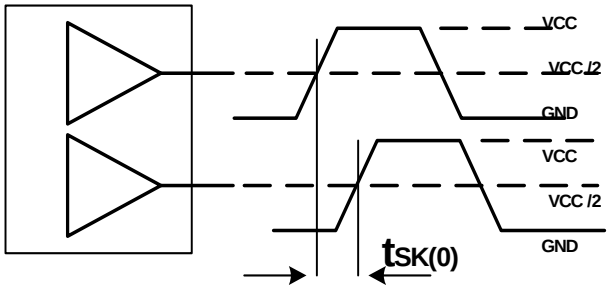


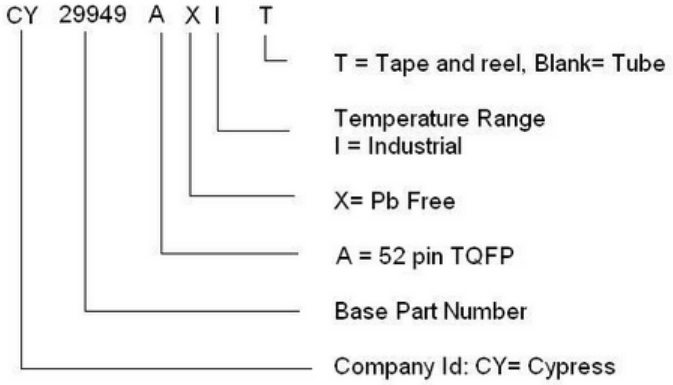
Figure 7. Output-to-Output Skew tsk(0)



Ordering Information

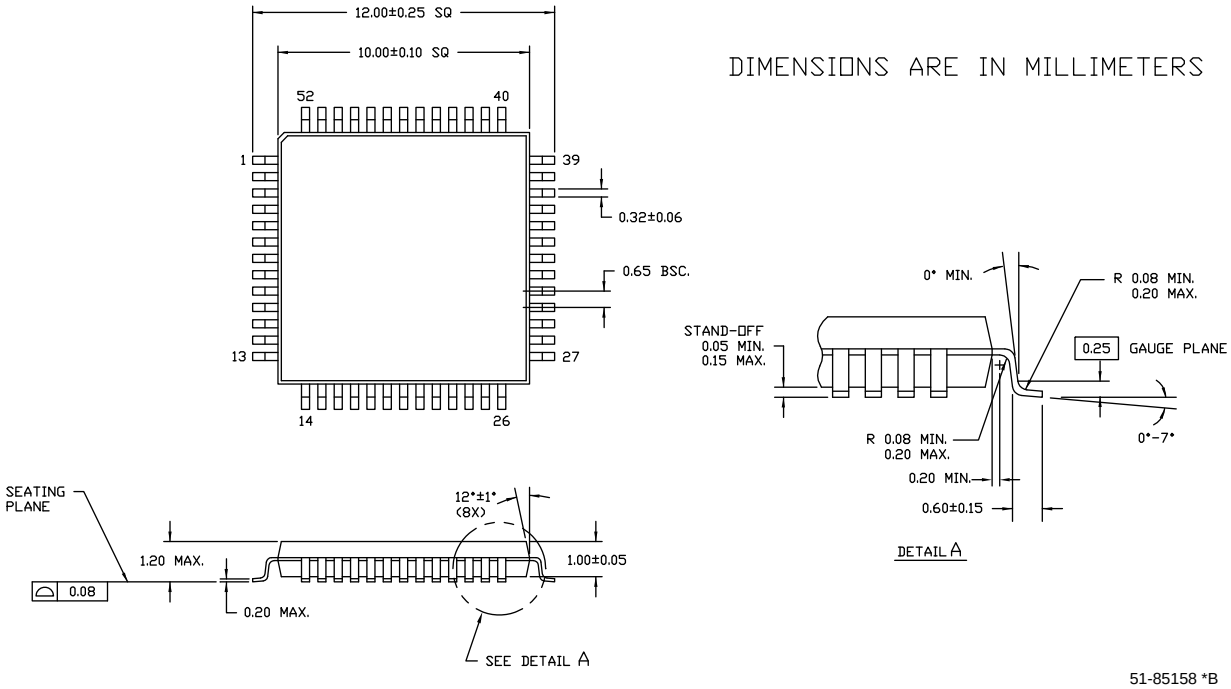
Part Number	Package Type	Production Flow
CY29949AXI	52-Pin TQFP	Industrial, –40°C to +85°C
CY29949AXIT	52-Pin TQFP - Tape and Reel	Industrial, –40°C to +85°C

Ordering Code Definitions



Package Drawing and Dimensions

Figure 8. 52-Pin Thin Plastic Quad Flat Pack (10 x 10 x 1.0 mm) A52B



Acronyms

Table 1. Acronyms Used in this Document

Acronym	Description
LVTTL	low voltage transistor-transistor logic
LVPECL	low voltage pseudo (positive) emitter coupled logic
LVCMOS	low voltage CMOS logic

Document Conventions

Units of Measure

Table 2. Units of Measure

Symbol	Unit of Measure
°C	degree Celsius
kv	kiloVolt
MHZ	megahertz
µA	microampere
mA	milliampere
ns	nanosecond
Ω	ohm
%	percent
pF	picofarad
ps	picosecond
V	volt

Document History Page

Document Title: CY29949 2.5 V or 3.3 V 200 MHz 1:15 Clock Distribution Buffer Document Number: 38-07289				
Revision	**ECN**	**Submission Date**	**Orig. of Change**	**Description of Change**
**	111100	02/01/02	BRK	New data sheet
*A	116783	08/14/02	HWT	Added commercial temperature range to the Ordering Information table
*B	118463	09/09/02	HWT	Corrected the package diagram from 52 LQFP to 52 TQFP
*C	122881	12/22/02	RBI	Added power-up requirements to Maximum Ratings
*D	130132	11/07/03	RGL	Fixed block diagram and MR/OE# description in the Pin Description table
*E	2595534	10/23/08	CXQ/PYRS	Changed to Pb-Free device code in Ordering Information
*F	3420718	10/24/11	PURU	Removed Commercial Information. Updated template according to current Cypress standards.

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